MI1206K900R-10

PHYSICAL DIMENSIONS:

MPEDANCE

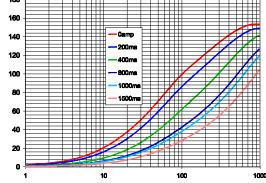
MPEDANCE

A 3.20 [.126] ± 0.20 [.008] B 1.60 [.063] ±0.20 [.008]

C 1.10 [.043] ± 0.20 [.008]

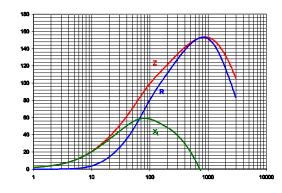
D 0.51 [.020] ± 0.25 [.010]

Z vs FREQUENCY IMPEDANCE UNDER DC BIAS



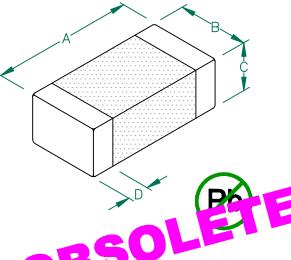
FREQUENCY (MHz)

|Z| , R, AND X vs. FREQUENCY



FREQUENCY (MHz)

AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 3337

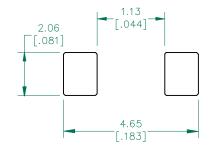


ELECTRICAL CHARACTERISTICS:								
Z @ 100MHz (Ω)		DCR (\(\Omega\)	Rated Current					
Nominal	90							
Minimum	68							
Maximum	113	0.080	1500 mA					

NOTES: UNLESS OTHERWISE SPECIFIED

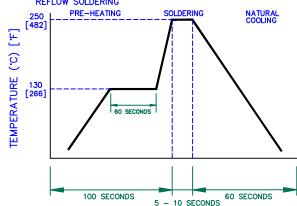
- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 3000 PCS/REEL.
- 2. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 3. TERMINATION FINISH IS 100% TIN.

LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.762 (0.030) to this dimension)

RECOMMENDED SOLDERING CONDITIONS REFLOW SOLDERING PRE-HEATING SOLDERING



	DIMENSIONS ARE IN mm [INCHE	THIS DOCUMENT CONTAINS INFORMATION WHICH IS PROPRIETARY AND CONFIDENTIAL TO STEWARD. NO PRODUCTION OR PUBLICATION OF								
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				Steward						
				PROJECT/PART NUMBER:	REV	PART TYPE:	DRAWN BY:			
				MI1206K900R-10	Α	CO-FIRE	JRK			
			_	06 /02 /04 I	ALE: N	TS SHEE	;			
A	ORIGINAL DRAFT	06/02/04	JRK	. , ,	OL #		of 2			